

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APL. NUM	FILING DATE	CLASS	SUBCLASS	GAU
10052687	01/18/2002	430	270	1752

APPLICANTS: Watanabe Satoshi; *YK*

CONTINUING DATA VERIFIED:

None *WAT*

FOREIGN APPLICATIONS VERIFIED:

JAPAN 2001-012947 01/22/2001 *DD*

PG-PUB DO NOT PUBLISH

RESCIND

Foreign priority claimed yes no

35 USC 119 conditions met yes no

Verified and Acknowledged Examiner's initials *AS*

ATTORNEY DOCKET NO.

5576-137

TITLE: Resist material and pattern forming method

U.S. DEPT. OF COMM./PAT. & T. PTO - SOLIC. 129

NOTICE OF ALLOWANCE MAILED

Assistant Examiner

CLAIMS ALLOWED

ISSUE FEE

1000

Amount Due Dated Paid

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TERMINAL

DRAWINGS

DISCLAIMER

1 Sheet(s) 1 Drawing(s)

PREPARED FOR ISSUE

Application Status

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